

I. Tracker

A. Pixels

1. Technology
 - a. Physical basis of charged particle detection by semiconductor
 - b. Silicon sensors with front end chips for readout
 - c. Optical readout
2. Physical structure
 - a. 46,080 pixels per sensor
 - b. Sensors generally 50x400 microns each
 - c. 16 sensors per module, 1744 modules total
 - d. 80 million channels, 1.4 m long, 0.5 m wide
3. Readout
 - a. On-detector lasers provide optical readout link
 - b. DAQ crates off-detector receive and interpret signals
 - c. Failures of lasers and motivation for alternatives
4. Relevance for b-tagging

B. SCT

1. Technology and structure
 - a. Silicon technology also
 - b. 4 double-sided layers, 6.36 x 6.40 cm
2. Role in track reconstruction

C. TRT

1. Technology, structure, readout
 - a. Ionization of gas when traversed by charged particle
 - b. 2-tier threshold system distinguishes between tracking hits and transition radiation
2. Particle identification role

II. Calorimeters

- A. Electromagnetic
- B. Hadronic

III. Muon System

IV. Trigger and Data Acquisition

- A. Three-Layer Trigger System

1. L1
 - a. Muon Stream
 - b. EGamma Stream
 - c. JetTauEtMiss Stream
 2. L2
 - a. Region of Interest readout based on L1 objects
 - b. More granular
 3. Event Filter
 - a. Full event reconstruction
 - b. Reconstruction time and rate
- B. Data Recording
- C. Event Reconstruction